

STF13NK50Z STP13NK50Z, STW13NK50Z

N-channel 500 V, 0.40 Ω, 11 A TO-220, TO-220FP, TO-247 Zener-protected SuperMESHTM Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D	Pw
STF13NK50Z	500 V	<0.48 Ω	11 A	30 W
STP13NK50Z	500 V	<0.48 Ω	11 A	140 W
STW13NK50Z	500 V	<0.48 Ω	11 A	140 W

- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitances
- Very good manufacturing repeatability

Applications

■ Switching application

Description

The SuperMESH™ series is obtained through an extreme optimization of ST's well established strip-based PowerMESH™ layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOSFETs.

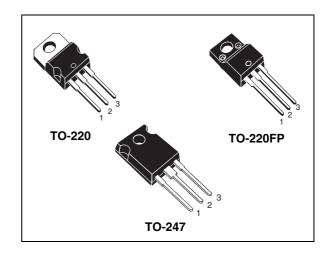


Figure 1. Internal schematic diagram

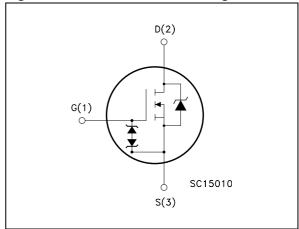


Table 1. Device summary

Order code	Marking	Package	Packaging
STF13NK50Z	F13NK50Z	TO-220FP	Tube
STP13NK50Z	P13NK50Z	TO-220	Tube
STW13NK50Z	W13NK50Z	TO-247	Tube

March 2009 Rev 2 1/15

Contents STx13NK50Z

Contents

1	Electrical ratings
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuit
4	Package mechanical data
5	Revision history

STx13NK50Z Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Combal	Parameter	Valu	Unit	
Symbol	Parameter	TO-220, TO-247	TO-220FP	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	500		V
V _{GS}	Gate-source voltage	± 30)	V
I _D	Drain current (continuous) at T _C = 25 °C	11	11 ⁽¹⁾	Α
I _D	Drain current (continuous) at T _C =100 °C	6.93	6.93 ⁽¹⁾	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	44	44 ⁽¹⁾	А
P _{TOT}	Total dissipation at T _C = 25 °C	140	30	W
	Derating factor	1.12	0.24	W/°C
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5		V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sin (t=1 s;T _C = 25 °C)		2500	V
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to ⁻	150	°C

- 1. Limited only by maximum temperature allowed
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \leq$ 11 A, di/dt \leq 200 A/ μ s, $V_{DD} \leq$ 80% $V_{(BR)DSS}$

Table 3. Thermal data

Symbol	Parameter		Unit		
Syllibol	Falanielei	TO-220	TO-247	TO-220FP	o iii
R _{thj-case}	Thermal resistance junction-case max	0.89		4.17	°C/W
R _{thj-a}	Thermal resistance junction-ambient max	62.5	50	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose		300		°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max)	11	А
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	240	mJ

Electrical characteristics STx13NK50Z

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	500			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating, T_{C} =125 °C			1 50	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			±10	μА
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 6.5 A		0.4	0.48	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 15 \text{ V}, I_D = 6.5 \text{ A}$		8.5		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0		1600 200 45		pF pF pF
Coss eq ⁽²⁾ .	Equivalent output capacitance	V _{GS} =0, V _{DS} =0 V to 400 V		50		pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =400 V, I_{D} = 13 A V_{GS} =10 V Figure 20		47 9 28		nC nC nC
R _g	Intrinsic gate resistance	f= 1 MHz open drain		2.3		Ω

^{1.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

Table 7. Switching times

	<u> </u>					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V _{DD} =400 V, I _D =6.5 A, R _G =4.7 Ω, V _{GS} =10 V		18 23		ns ns
t _{d(off)}	Turn-off delay time Fall time	Figure 19		61 24		ns ns

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				11	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				44	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} =11 A, V _{GS} =0			1.6	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =6.5 A, di/dt = 100 A/ μ s, V_{DD} =40 V, Tj=25 °C Figure 21		380 3.4 18		ns μC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =6.5 A, di/dt = 100 A/ μ s, V_{DD} =40 V, Tj=150 °C Figure 21		425 3.9 18.5		ns μC Α

- 1. Pulse width limited by safe operating area
- 2. Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 9. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
BV _{GSO} (1)	Gate-source breakdown voltage	Igs=±1 mA (open drain)	30			V

^{1.} The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

Electrical characteristics STx13NK50Z

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220 Figure 3. Thermal impedance for TO-220

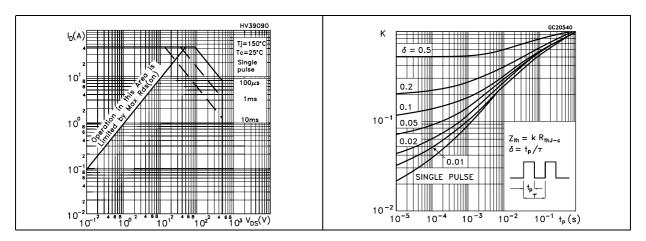


Figure 4. Safe operating area for TO-220FP Figure 5. Thermal impedance for TO-220FP

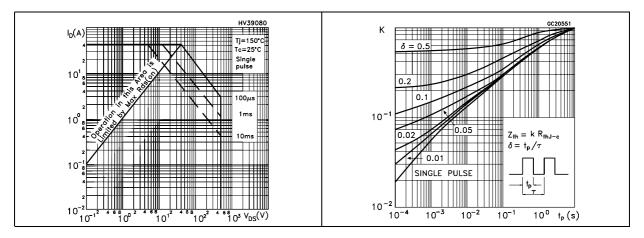


Figure 6. Safe operating area for TO-247 Figure 7. The same of the

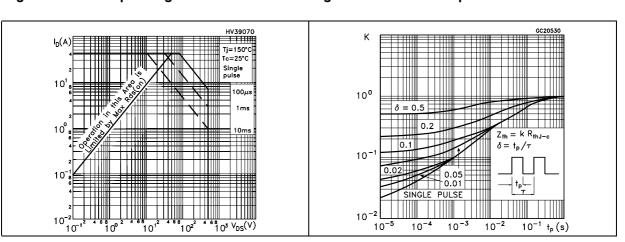
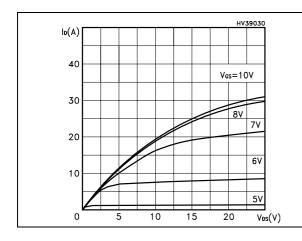


Figure 7. Thermal impedance for TO-247

Figure 8. Output characteristics

Figure 9. Transfer characteristics



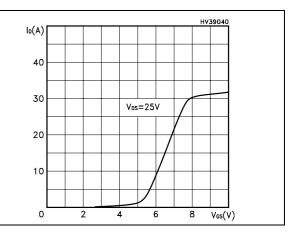
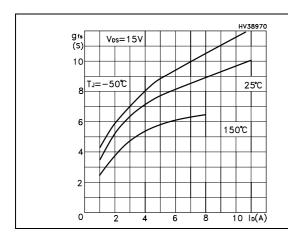


Figure 10. Transconductance

Figure 11. Static drain-source on resistance



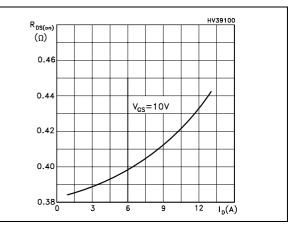
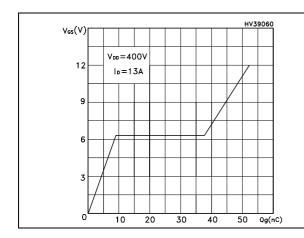
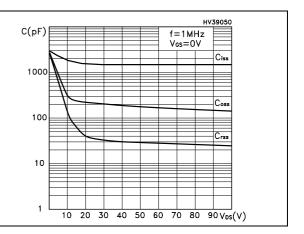


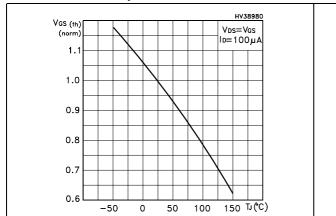
Figure 12. Gate charge vs gate-source voltage Figure 13. Capacitance variations





Electrical characteristics STx13NK50Z

Figure 14. Normalized gate threshold voltage Figure 15. Normalized on resistance vs vs temperature temperature



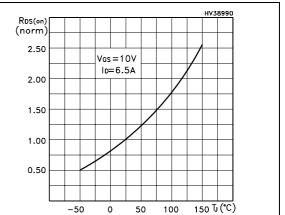
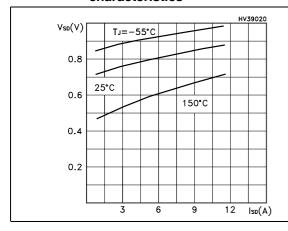


Figure 16. Source-drain diode forward characteristics

Figure 17. Normalized B_{VDSS} vs temperature



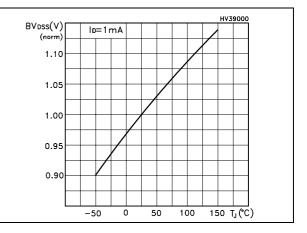
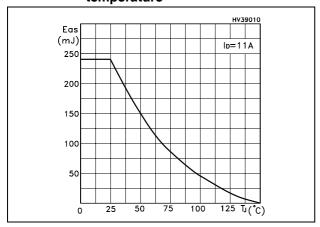


Figure 18. Maximum avalanche energy vs temperature



8/15

STx13NK50Z Test circuit

3 Test circuit

Figure 19. Switching times test circuit for resistive load

Figure 20. Gate charge test circuit

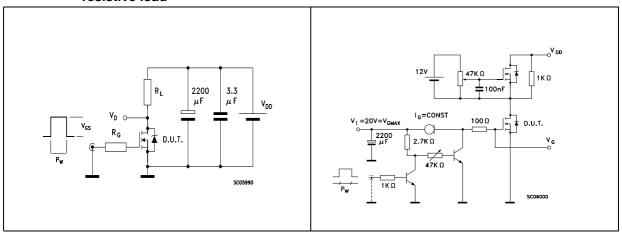


Figure 21. Test circuit for inductive load switching and diode recovery times

Figure 22. Unclamped inductive load test circuit

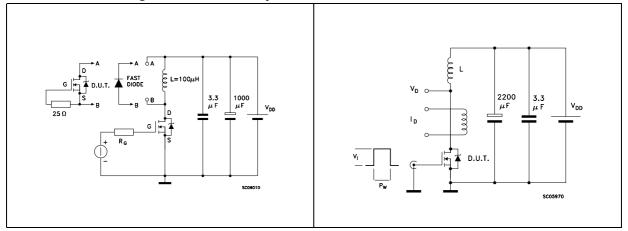
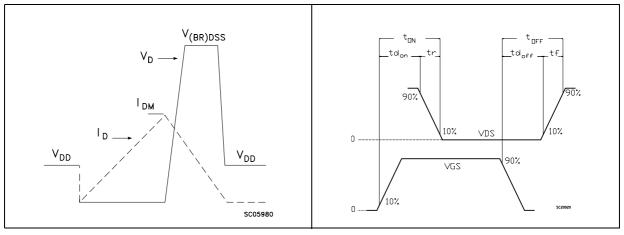


Figure 23. Unclamped inductive waveform

Figure 24. Switching time waveform

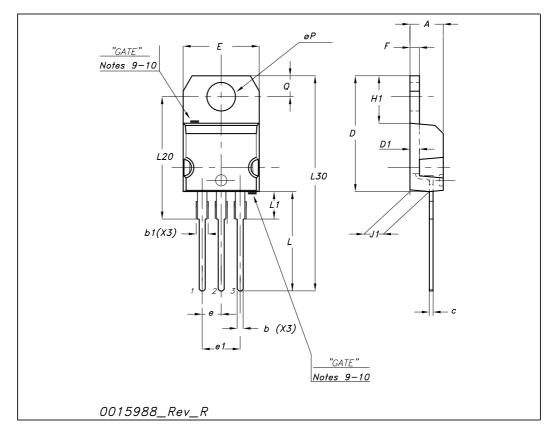


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

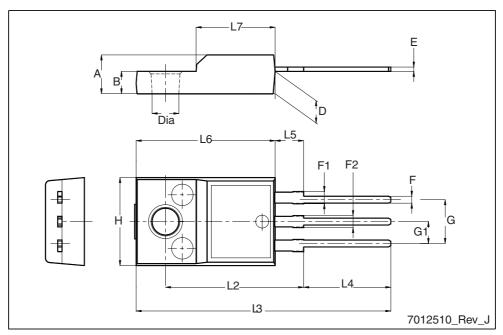
TO-220 mechanical data

Dim		mm			inch	
Dim	Min	Тур	Max	Min	Тур	Max
А	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.48		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90	İ		1.137	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



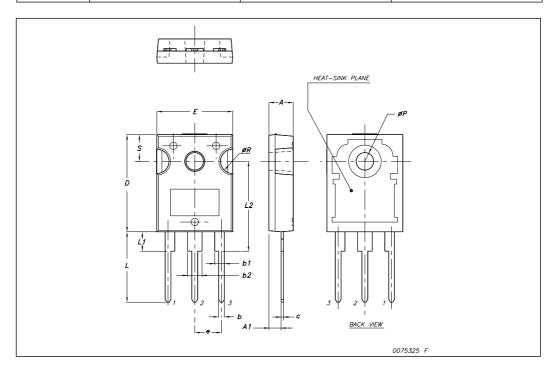
TO-220FP mechanical data

Dim.	mm			
	Min.	Тур.	Max.	
А	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.5	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	



TO-247	Mechai	nical	data

Dim.	mm.			
	Min.	Тур	Max.	
Α	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øΡ	3.55		3.65	
øR	4.50		5.50	
S		5.50		



Revision history STx13NK50Z

5 Revision history

Table 10. Revision history

Date	Revision	Changes	
07-Aug-2007	1	First version	
19-Mar-2009	2	Update I _D value test condition in <i>Table 6</i> .	

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